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Vishay Siliconix

Automotive N-Channel 80 V (D-S) 175 °C MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	80				
$R_{DS(on)}(\Omega)$ at $V_{GS} = 10 \text{ V}$	0.003				
I _D (A)	150				
Configuration	Single				
Package	PowerPAK 8 x 8L				

PowerPAK® 8 x 8L Single One of the state of

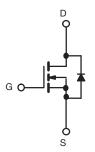
FEATURES

- TrenchFET® power MOSFET
- AEC-Q101 qualified
- 100 % R_q and UIS tested
- Fully lead (Pb)-free device
- Thin 1.9 mm height
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>









N-Channel MOSFET

ABSOLUTE MAXIMUM RATIN	GS ($T_C = 25$ °C, unles	s otherwise noted	i)		
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage		V _{DS}	80	V	
Gate-Source Voltage		V_{GS}	V _{GS} ± 20		
Continuous Drain Current	T _C = 25 °C	1	150		
Continuous Drain Current	T _C = 125 °C	I _D	87		
Continuous Source Current (Diode conduc	Is	124	Α		
Pulsed Drain Current ^a	I _{DM}	210			
Single Pulse Avalanche Current		I _{AS}	53		
Single Pulse Avalanche Energy L = 0.1 mH		E _{AS}	140	mJ	
Maximum Dower Dissipation	T _C = 25 °C	D	136	W	
Maximum Power Dissipation	T _C = 125 °C	P_{D}	45	VV	
Operating Junction and Storage Temperat	T _J , T _{stg}	-55 to +175	°C		
Soldering Recommendations (Peak temper	-	260	C		

THERMAL RESISTANCE RATINGS							
PARAMETER		SYMBOL	LIMIT	UNIT			
Junction-to-Ambient	PCB mount b	R _{thJA}	50	°C/W			
Junction-to-Case (Drain)		R _{thJC}	1.1	C/VV			

Notes

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. When mounted on 1" square PCB (FR4 material).
- c. See solder profile (www.vishay.com/doc?73257). The PowerPAK 8 x 8L is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- d. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.



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PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static				I.	l	l	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0$, $I_D = 250 \mu A$		80	-	-	V
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = 250 μA	2.5	3	3.5	V
Gate-Source Leakage	I _{GSS}	V _{DS} =	0 V, V _{GS} = ± 20 V	-	-	± 100	nA
		$V_{GS} = 0 V$	V _{DS} = 80 V	-	-	1	
Zero Gate Voltage Drain Current	I _{DSS}	V _{GS} = 0 V	V _{DS} = 80 V, T _J = 125 °C	-	-	50	μA
		V _{GS} = 0 V	V _{DS} = 80 V, T _J = 175 °C	-	-	500	
On-State Drain Current ^a	I _{D(on)}	V _{GS} = 10 V	$V_{DS} \ge 5 V$	50	-	-	Α
Drain-Source On-State Resistance a		V _{GS} = 10 V	I _D = 20 A	-	0.0024	0.0030	Ω
	R _{DS(on)}	V _{GS} = 10 V	I _D = 20 A, T _J = 125 °C	-	-	0.0048	
		V _{GS} = 10 V	I _D = 20 A, T _J = 175 °C	-	-	0.0060	
Forward Transconductance b	9 _{fs}	V _{DS} = 15 V, I _D = 15 A		-	82	-	S
Dynamic ^b							
Input Capacitance	C _{iss}			-	6900	8625	
Output Capacitance	Coss	$V_{GS} = 0 \text{ V}$ $V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$		-	3655	4570	рF
Reverse Transfer Capacitance	C _{rss}]		-	250	311	1
Total Gate Charge c	Qg			-	82	144	
Gate-Source Charge c	Q _{gs}	V _{GS} = 10 V	$V_{DS} = 40 \text{ V}, I_{D} = 10 \text{ A}$	-	11	-	nC
Gate-Drain Charge ^c	Q_{gd}				21	-	
Gate Resistance	R _g		f = 1 MHz		0.8	1.2	Ω
Turn-On Delay Time ^c	t _{d(on)}			-	19	30	
Rise Time ^c	t _r	$V_{DD} = 40 \text{ V}, \text{ R}_L = 4 \Omega$ $I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, \text{ R}_g = 1 \Omega$		-	7.3	11	ns
Turn-Off Delay Time ^c	t _{d(off)}			-	40	60	
Fall Time ^c	t _f			-	15	23	
Source-Drain Diode Ratings and Cha	racteristics b						
Pulsed Current ^a	I _{SM}			-	-	210	Α
Forward Voltage	V _{SD}	I _F = 40 A, V _{GS} = 0 V		_	0.7	1.2	V

Notes

- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.
- c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



1.2

1.0

8.0

0.6

0.4

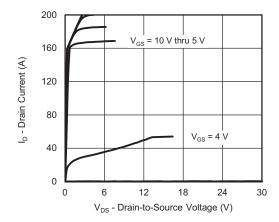
0.2

0.0

0

I_D - Drain Current (A)

TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



Output Characteristics



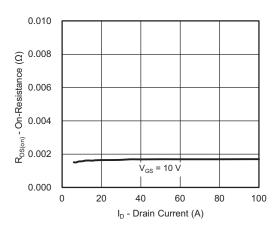
= -55 °C

5

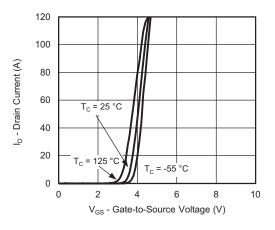
Transfer Characteristics

V_{GS} - Gate-to-Source Voltage (V)

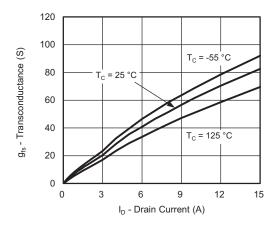
T_C = 25



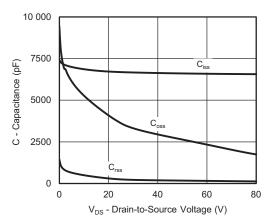
On-Resistance vs. Drain Current



Transfer Characteristics



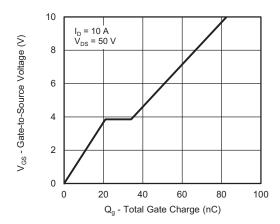
Transconductance



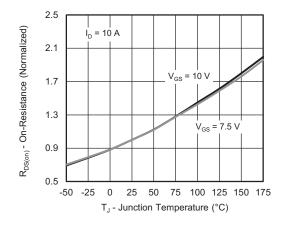
Capacitance



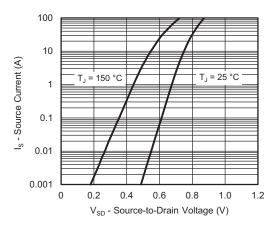
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



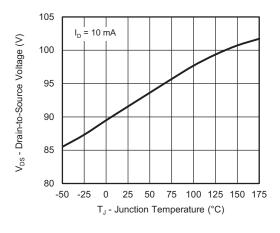
Gate Charge



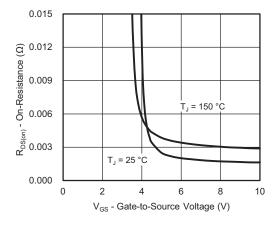
On-Resistance vs. Junction Temperature



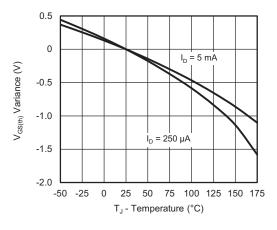
Source Drain Diode Forward Voltage



Drain Source Breakdown vs. Junction Temperature



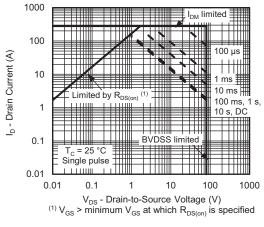
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage

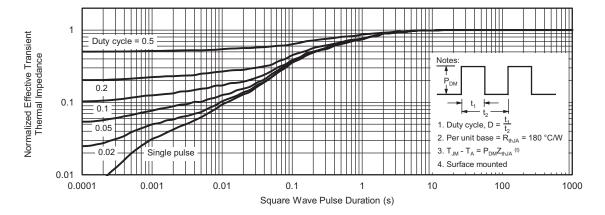


TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



Safe Operating Area

THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)

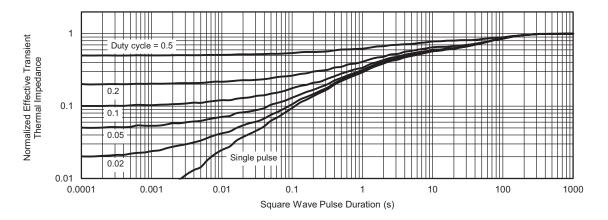


Normalized Thermal Transient Impedance, Junction-to-Ambient

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THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)

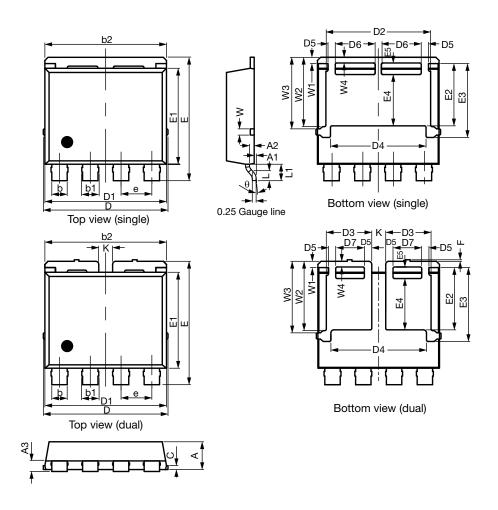


Normalized Thermal Transient Impedance, Junction-to-Case

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?76718.



PowerPAK® 8 x 8L Case Outline



DIM		MILLIMETERS		INCHES		
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
Α	1.70	1.80	1.90	0.067	0.071	0.075
A1	0.00	0.08	0.13	0.000	0.003	0.005
A2	0.25	0.30	0.35	0.010	0.012	0.014
A3	0.55	0.62	0.70	0.022	0.024	0.028
b	0.92	1.00	1.08	0.036	0.039	0.043
b1	1.02	1.10	1.18	0.040	0.043	0.046
b2	7.80	7.90	8.00	0.307	0.311	0.315
С	0.20	0.25	0.30	0.008	0.010	0.012
D	8.00	8.10	8.25	0.315	0.319	0.325
D1	7.80	7.90	8.00	0.307	0.311	0.315
D2	6.70	6.80	6.90	0.264	0.268	0.272
D3	2.85	2.95	3.05	0.112	0.116	0.120
D4	6.11	6.21	6.31	0.241	0.244	0.248
D5	0.37	0.47	0.57	0.015	0.019	0.022
D6	2.49	2.59	2.69	0.098	0.102	0.106
D7	1.76	1.86	1.96	0.069	0.073	0.077

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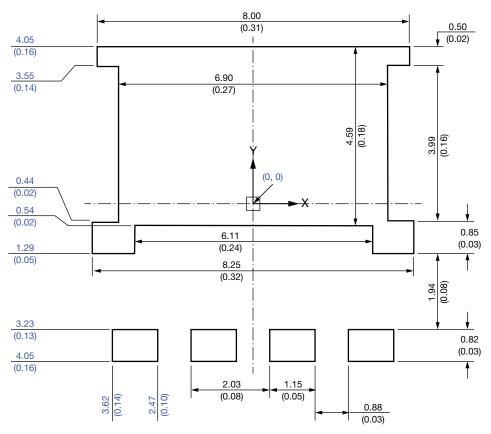
DIM		MILLIMETERS		INCHES			
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.	
е	1.95	2.00	2.05	0.077	0.079	0.081	
Е	7.90	8.00	8.10	0.311	0.315	0.319	
E1	6.12	6.22	6.32	0.241	0.245	0.249	
E2	3.94	4.04	4.14	0.140	0.159	0.163	
E3	4.69	4.79	4.89	0.185	0.189	0.193	
E4	3.23	3.33	3.43	0.127	0.131	0.135	
E5	0.65	0.75	0.85	0.026	0.030	0.033	
F	0.00	0.10	0.15	0.000	0.004	0.006	
L	0.62	0.72	0.82	0.024	0.028	0.032	
L1	0.92	1.07	1.22	0.036	0.042	0.048	
K	0.80	0.90	1.00	0.031	0.035	0.039	
W	0.30	0.40	0.50	0.012	0.016	0.020	
W1	0.30	0.40	0.50	0.012	0.016	0.020	
W2	4.39	4.49	4.59	0.173	0.177	0.181	
W3	4.54	4.64	4.74	0.179	0.183	0.187	
W4	0.32	0.37	0.42	0.013	0.015	0.017	
θ	6°	10°	14°	6°	10°	14°	

C17-1388-Rev. B, 16-Oct-17

DWG: 6026



Recommended Minimum PADs for PowerPAK® 8 x 8L Single



Dimensions in millimeters (inches)

Note

• Linear dimensions are in black, the same information is provided in ordinate dimensions which are in blue.



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